





Features and Benefits

Chopper stabilized amplifier stage

Optimized for brushless DC motor applications

■ Miniature high reliability package

Operation down to 3.5V

CMOS for optimum stability, quality and cost

Low power consumption

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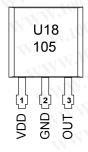
Ordering Information

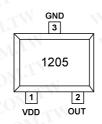
Part No.	Temperature Suffix	Package Code
US1881	E (-40 °C to 85 °C)	SO (SOT-23) or UA(TO-92)
US1881	K (-40 °C to 125 °C)	SO (SOT-23) or UA(TO-92)
US1881	L (-40 °C to 150 °C)	SO (SOT-23) or UA(TO-92)

Applications

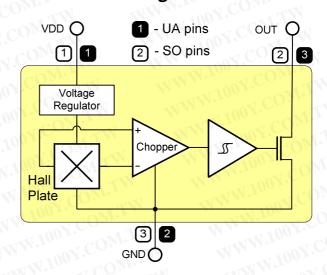
- Solid state switch
- Brushless DC motor commutation
- Speed Sensing
- Linear position sensing
- Angular position sensing
- Current sensing

Pinout:





1 Functional Diagram



UA Package: SO Package:

Pin1: VDD - supply
Pin2: GND - Ground
Pin3: OUT - Output
Pin3: GND - Ground

Note: Static electricity sensitive device; please observe ESD precautions. Reverse voltage protection is not included. For reverse polarity protection, a 1000 hm resistor in series with V_{DD} is recommended.

2 Description

The US1881 is the industry's first Hall integrated circuit in SOT-23 package. The US1881 is a bipolar Hall effect sensor IC based on mixed signal CMOS technology. It incorporates advanced chopper stabilization techniques to provide accurate and stable magnetic switch points. There are many applications for this HED in addition to those listed above. The design, specifications and performance have been optimized for commutation applications in 5V and 12V brushless DC motors.

In UA packaged device the output transistor will be latched on (Bop) in presence of a sufficiently strong South pole magnetic field facing the marked side of the package. Similarly, the output will be latched off (Brp) in the presence of a North field. The SOT-23 device behaviour is reverse to the UA device. The SOT-23 output transistor will be latched on (B_{OP}) in the presence of a sufficiently strong North pole magnetic field on the marked side.





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Glossary of Terms

MilliTesla (mT), Gauss: Units of magnetic flux density; 1 milliTesla = 10 Gauss.

CMOS - Complementary Metal-Oxide Silicon - A technology for building logic circuits that employs both "N" and "P" channel MOS transistors. It allows one to make ICs with lots of transistors that consume small amounts of power.

Absolute Maximum Ratings

Parameter	Symbol	Value	Units
Supply Voltage (Operating)	V_{DD}	24	CON
Supply Current (Fault)	I _{DD}	50	mA
Output Voltage	V _{OUT}	24	Vov
Output Current (Fault)	I _{OUT}	50	mA
Power Dissipation, UA/SO packages	P_{D}	700/389	mW
Maximum Junction Temperature	TWTJ	165	00℃
Storage Temperature	T _s	-50 to 150	°C

Exceeding the absolute maximum ratings may cause permanent damage. Exposure to absolute-maximumrated conditions for extended periods may affect device reliability.

Operating Temperature Range	Value	Units
Temperature Suffix "E"	-40 to 85	S
Temperature Suffix "K"	-40 to 125	℃
Temperature Suffix "L"	-40 to 150	လူ

US1881 Electrical Characteristics

Parameter	Symbol	Test Conditions	Min	Тур	Max	Units
Supply Voltage	VDD	Operating	3.5		24	V
Supply current	I_{DD}	B < B _{OP}	1.1	2.0	5.0	mA
Saturation Voltage	V _{DS(on)}	$I_{OUT} = 20 \text{mA}, B > B_{op}, V_{DD} = 4.5 \div 18 \text{V}$	V	0.4	0.5	V
Output Leakage	I _{OFF}	B < B _{RP} , V _{OUT} =24V	Lin	0.01	10	uA
Output Rise Time	t _r	$V_{DD} = 12V, R_L = 1k, C_L = 20pF$	TW	0.04		us
Output Fall Time	$t_{\rm f}$	$V_{DD} = 12V, R_L = 1k, C_L = 20pF$	TIN	0.18	MA	us
Maximum Switching	fsw	Operating	WILL	10	MM	KHz
Frequency	N. Love Co	MAN. TONY.CC	TY	V	W	N.

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Magnetic Characteristics

Parameter	Symbol	Test Conditions	Min	Тур	Max	Units
Operating Point	B _{OP}	E/LUA, E/LSO,Ta=25°C,Vdd=3.5 24V DC	1.0	5.0	9.0	mT
Release Point	B _{RP}	E/LUA, E/LSO,Ta=25°C,Vdd=3.5 24V DC	-9.0	-5.0	-1.0	mT
Hysteresis	B _{HYS}	E/LUA, E/LSO,Ta=25°C,Vdd=3.5 24V DC	7.0	10.0	12.0	mT
Operating Point	B _{OP}	EUA, ESO, Ta=85°C,Vdd=3.5 24V DC	0.5	5.0	9.5	mT
Release Point	B _{RP}	EUA, ESO, Ta=85°C,Vdd=3.5 24V DC	-9.5	-5.0	√ -0.5	mT
Hysteresis	B _{HYS}	EUA, ESO, Ta=85°C,Vdd=3.5 24V DC	7.0	10.0	12.0	mT
Operating Point	B _{OP}	KUA, KSO, Ta=125°C,Vdd=3.5 24V DC	0.5	5.0	9.5	mT
Release Point	B _{RP}	KUA, KSO, Ta=125°C,Vdd=3.5 24V DC	-9.5	-5.0	-0.5	mT
Hysteresis	B _{HYS}	KUA, KSO, Ta=125°C,Vdd=3.5 24V DC	7.0	10.0	12.0	mT
Operating Point	B _{OP}	LUA, LSO, Ta=150°C,Vdd=3.5 24V DC	0.5	5.0	9.5	mT
Release Point	B _{RP}	LUA, LSO, Ta=150°C,Vdd=3.5 24V DC	-9.5	-5.0	-0.5	mT
Hysteresis	B _{HYS}	LUA, LSO, Ta=150°C,Vdd=3.5 24V DC	6.0	10.0	12.5	mT

Unique Features

CMOS Hall IC Technology

The chopper stabilized amplifier uses switched capacitor techniques to eliminate the amplifier offset voltage, which, in bipolar devices, is a major source of temperature sensitive drift. CMOS makes this advanced technique possible. The CMOS chip is also much smaller than a bipolar chip, allowing very sophisticated circuitry to be placed in less space. The small chip size also contributes to lower physical stress and less power consumption.

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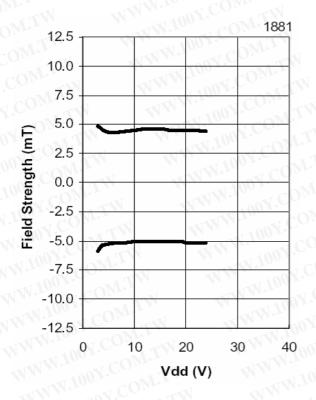
US1881

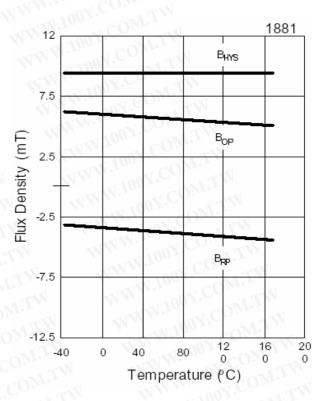
CMOS Multi-Purpose Latch

8 Performance Graphs – unless otherwise specified Ta=25°C, VDD=12V

8.1 Typical Magnetic Switch Points vs V_{DD}

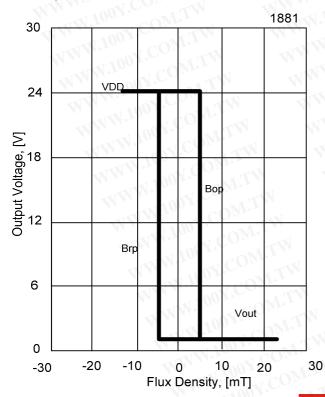


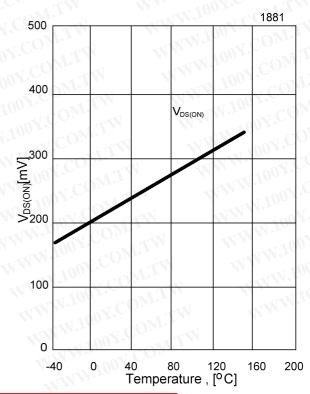




8.3 Output Voltage vs Magnetic Flux Density 8 (Hysteresis)

Typical Saturation Voltage vs Temperature(V_{DD} =12V;lout=20mA)



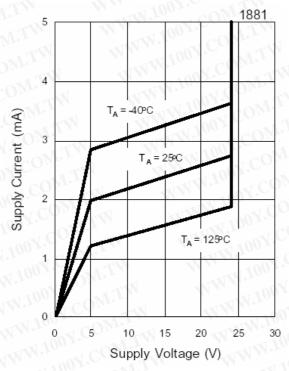


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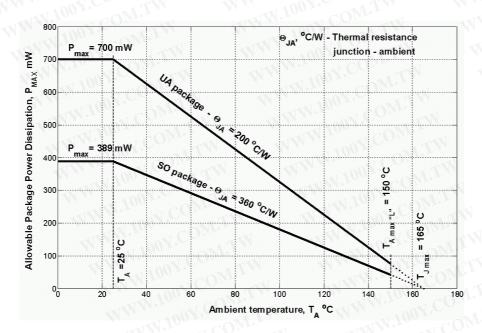
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8.5 Typical Supply Current vs V_{DD}



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8.6 Maximal Power Dissipation (MPD) Versus Temperature



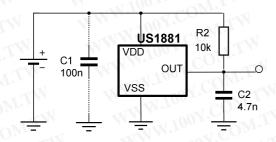
The thermal resistance Θ_{IA} and rated power dissipation are defined in accordance with EIA/JESD51-3 Standard.

Some differences may be observed between values in the specification tables and the performance graphs. The performance graphs are based on initial characterization of several ICs from one lot. Hence a particular IC may vary from the performance graphs but all ICs should meet the values stated in the specification tables.

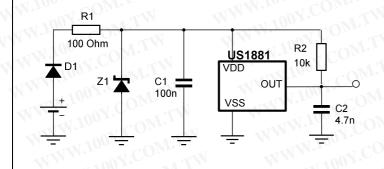


9 Application Information

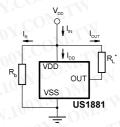
9.1 Typical Three-Wire Application Circuit



9.3 Automotive and Harsh, Noisy Environments Three-Wire Circuit



9.2 Two-Wire Circuit



Note:

With this circuit, precise ON and OFF currents can be detected using only two connecting wires.

The resistors RL and Rb can be used to bias the input current. Refer to the part specifications for limiting values.

$$\begin{split} B_{RP}: \quad I_{OFF} &= I_R \ + I_{DD} = V_{DD}/R_b + I_{DD} \\ B_{OP}: \quad I_{ON} &= I_{OFF} + I_{OUT} = I_{OFF} + V_{DD}/R_L \end{split}$$

10 Application Comments

If a weak power supply is used or the chip is intended to be used in noisy environment, it is recommended that figure 9.3 from the Application Information section is used. R1 and C1 form a RC filter, which bypasses the disturbances over the supply pin.

If a continuous reverse polarity protection is required for supply voltages above 5 Volts, it is recommended to use a diode instead of resistor, because the power dissipation demands become higher.

11 Pin Definitions and Descriptions

UA	SO Dine	Pin	Туре	Description
Pins 1	Pins 1	Name VDD	Supply	Power Supply pin
3	2	OUT	Output	Hall output pin (clamped)
2	3	VSS	Ground	Ground pin

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12 Reliability Information

This Melexis device is classified and qualified regarding soldering technology, solderability and moisture sensitivity level, as defined in this specification, according to following test methods:

- IPC/JEDEC J-STD-020
 Moisture/Reflow Sensitivity Classification For Nonhermetic Solid State Surface Mount Devices (classification reflow profiles according to table 5-2)
- EIA/JEDEC JESD22-A113
 Preconditioning of Nonhermetic Surface Mount Devices Prior to Reliability Testing (reflow profiles according to table 2)
- CECC00802
 Standard Method For The Specification of Surface Mounting Components (SMDs) of Assessed Quality
- EIA/JEDEC JESD22-B106
 Resistance to soldering temperature for through-hole mounted devices
- EN60749-15
 Resistance to soldering temperature for through-hole mounted devices
- MIL 883 Method 2003 / EIA/JEDEC JESD22-B102 Solderability

For all soldering technologies deviating from above mentioned standard conditions (regarding peak temperature, temperature gradient, temperature profile etc) additional classification and qualification tests have to be agreed upon with Melexis.

The application of Wave Soldering for SMD's is allowed only after consulting Melexis regarding assurance of adhesive strength between device and board.

Based on Melexis commitment to environmental responsibility, European legislation (Directive on the Restriction of the Use of Certain Hazardous substances, RoHS) and customer requests, Melexis has installed a Roadmap to qualify their package families for lead free processes also. Various lead free generic qualifications are running, current results on request.

For more information on Melexis lead free statement see quality page at our website: http://www.melexis.com/html/pdf/MLXleadfree-statement.pdf

13 ESD Precautions

Electronic semiconductor products are sensitive to Electro Static Discharge (ESD).

Always observe Electro Static Discharge control procedures whenever handling semiconductor products.

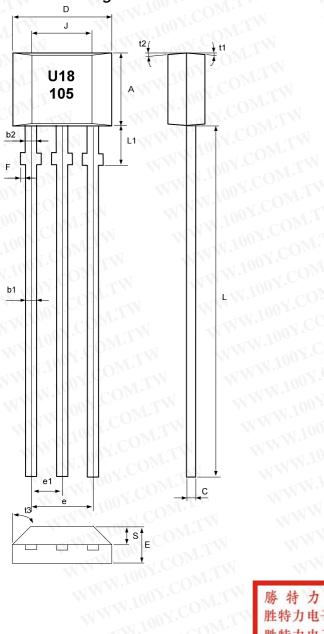
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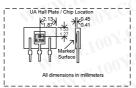




14 Physical Characteristics

UA Package Information





MARKING

Line 1: 1st letter (U) =Supplier (Melexis) 2nd and 3rd digits(18) =Series (1881)

nd and 3 rd d	ligits(18) =	Series (18	81)
ine2: ^{Ist} digit (1) ^{2nd} and 3 rd d		=Year (200° =Week of th	
Symbols	Dimens	ions in mi	llimeters
Cymbols	min	nom	max
Α	2.80	3.00	3.20
b1	0.35	0.38	0.41
b2	0.43	0.46	0.48
С	0.35	0.38	0.41
D	3.90	4.10	4.30
е	2.51	2.54	2.57
e1	1.24	1.27	1.30
TEL.	1.40	1.50	1.60
J	2.51	2.62	2.72
~EA.	14.0	14.5	15.0
S	0.63	0.74	0.84
t3	- 1	45°	- 47
t2		5°	
t1	4	-	5°
- L1	1.55	1.65	1.75
F	0	114-	0.20
	Mrs	-1	
V		W	

- 1. Controlling Dimension: mm
- 2. Tolerance: +/-0.004" unless otherwise specified
 3. Package dimensions exclude molding
- 4. The end flash shall not exceed 0.005" on

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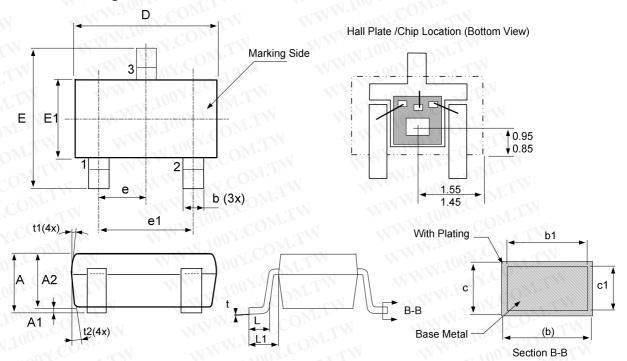
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SOT23 Package Information



Note:

- 1. Controlling Dimension: mm
- 2. Dimension D does not include mold flash, protrusions or gate burrs. Mold flash, protrusions or gate burrs shall not exceed 0.10mm per side.
- 3. Dimension E1 does not include interlead flash or protrusion shall not exceed 0.10mm per side.
- 4. The package top may be smaller than the package bottom. Dimensions D and E1 are determined at the outermost extremes of the plastic body exclusive or mold flash, tie bar burrs, interlead flash and gate burrs, but including any mismatch between the top and bottom of the molded body.
- 5. The section B-B applies to the flat section of the lead between 0.08mm and 0.15mm from the lead tip.
- 6. Marking (on top of the chip)

- First Digit (1) - part number; YXX- date code(Y - last digit of the Year, XX - week)

Cumple	Dimer	sions in mil	limeters
Symbols	min	nom	max
Α	1.05	MIN	1.35
A1	0.05		0.15
A2	1.00	1.10	1.20
b	0.25	N In	0.50
b1	0.25	0.40	0.45
С	0.08	-11	0.20
c1	0.08	0.11	0.15
D	2.70	2.90	3.00
CE	2.60	2.80	3.00
E1	1.50	1.60	1.70
Y L	0.35	0.45	0.55
L1CU	Mr.	0.60 REF	41111
е	M_{II}	0.95 BSC	7
e1	1	1.90 BSC	MA
t_10	00	50	10 ⁰
1 (t1) 1	30	5 ⁰	7 ⁰
t2	60	80	10 ⁰

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US1881



CMOS Multi-Purpose Latch

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